

Si4410DY

N-channel enhancement mode field-effect transistor

Rev. 02 — 05 July 2001

Product data

1. Description

N-channel enhancement mode field-effect transistor in a plastic package using TrenchMOS™¹ technology.

Product availability:

Si4410DY in SOT96-1 (SO8).

2. Features

- Low on-state resistance
- Fast switching
- TrenchMOS™ technology.

3. Applications

- DC to DC convertors
- DC motor control
- Lithium ion battery applications
- Notebook PC
- Portable equipment applications.

4. Pinning information

Table 1: Pinning - SOT96-1, simplified outline and symbol

Pin	Description	Simplified outline	Symbol
1,2,3	source (s)	<p>Top view MBK187</p> <p>SOT96-1 (SO8)</p>	<p>MBB076</p>
4	gate (g)		
5,6,7,8	drain (d)		

1. TrenchMOS is a trademark of Royal Philips Electronics.

5. Quick reference data

Table 2: Quick reference data

Symbol	Parameter	Conditions	Typ	Max	Unit
V_{DS}	drain-source voltage (DC)	$T_j = 25$ to 150 °C	–	30	V
I_D	drain current	$T_{amb} = 25$ °C; pulsed; $t_p \leq 10$ s	–	10	A
P_{tot}	total power dissipation	$T_{amb} = 25$ °C; pulsed; $t_p \leq 10$ s	–	2.5	W
T_j	junction temperature		–	150	°C
R_{DSon}	drain-source on-state resistance	$V_{GS} = 10$ V; $I_D = 10$ A; $T_j = 25$ °C	11	13.5	mΩ
		$V_{GS} = 4.5$ V; $I_D = 5$ A; $T_j = 25$ °C	15	20	mΩ

6. Limiting values

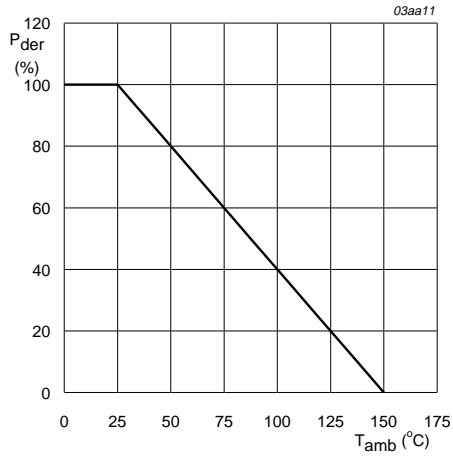
Table 3: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage (DC)	$T_j = 25$ to 150 °C	–	30	V
V_{GS}	gate-source voltage (DC)		–	±20	V
I_D	drain current	$T_{amb} = 25$ °C; pulsed; $t_p \leq 10$ s; Figure 2 and 3	–	10	A
		$T_{amb} = 70$ °C; pulsed; $t_p \leq 10$ s; Figure 2	–	8	A
I_{DM}	peak drain current	$T_{amb} = 25$ °C; pulsed; $t_p \leq 10$ μs; Figure 3	–	50	A
P_{tot}	total power dissipation	$T_{amb} = 25$ °C; pulsed; $t_p \leq 10$ s; Figure 1	–	2.5	W
		$T_{amb} = 70$ °C; pulsed; $t_p \leq 10$ s; Figure 1	–	1.6	W
T_{stg}	storage temperature		–55	+150	°C
T_j	operating junction temperature		–55	+150	°C

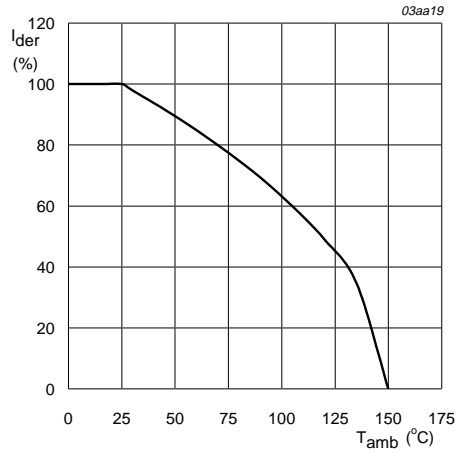
Source-drain diode

I_S	source (diode forward) current	$T_{amb} = 25$ °C; pulsed; $t_p \leq 10$ s	–	2.3	A
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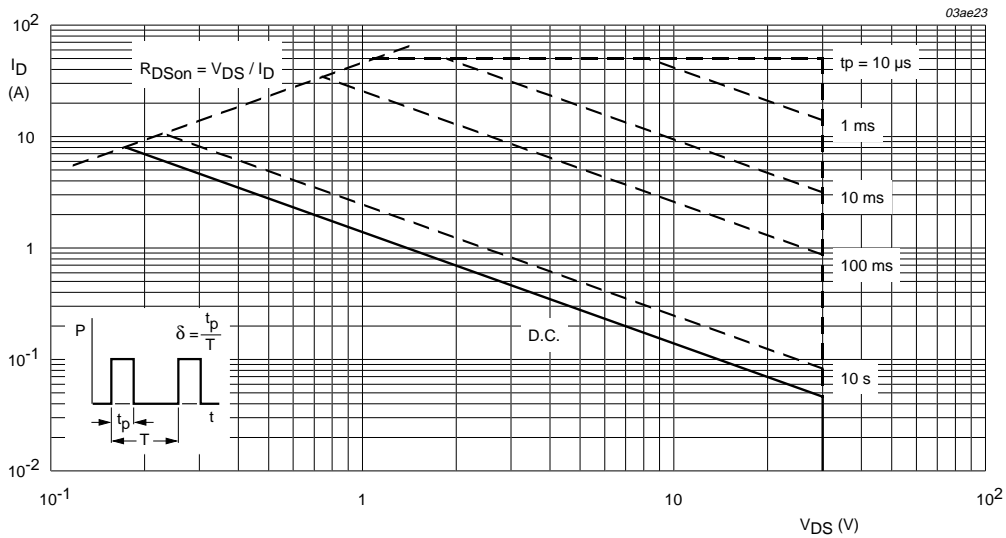
$$P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}\text{C})}} \times 100\%$$

Fig 1. Normalized total power dissipation as a function of mounting base temperature.



$$I_{der} = \frac{I_D}{I_{D(25^{\circ}\text{C})}} \times 100\%$$

Fig 2. Normalized continuous drain current as a function of mounting base temperature.



T_{amb} = 25 °C; I_{DM} is single pulse.

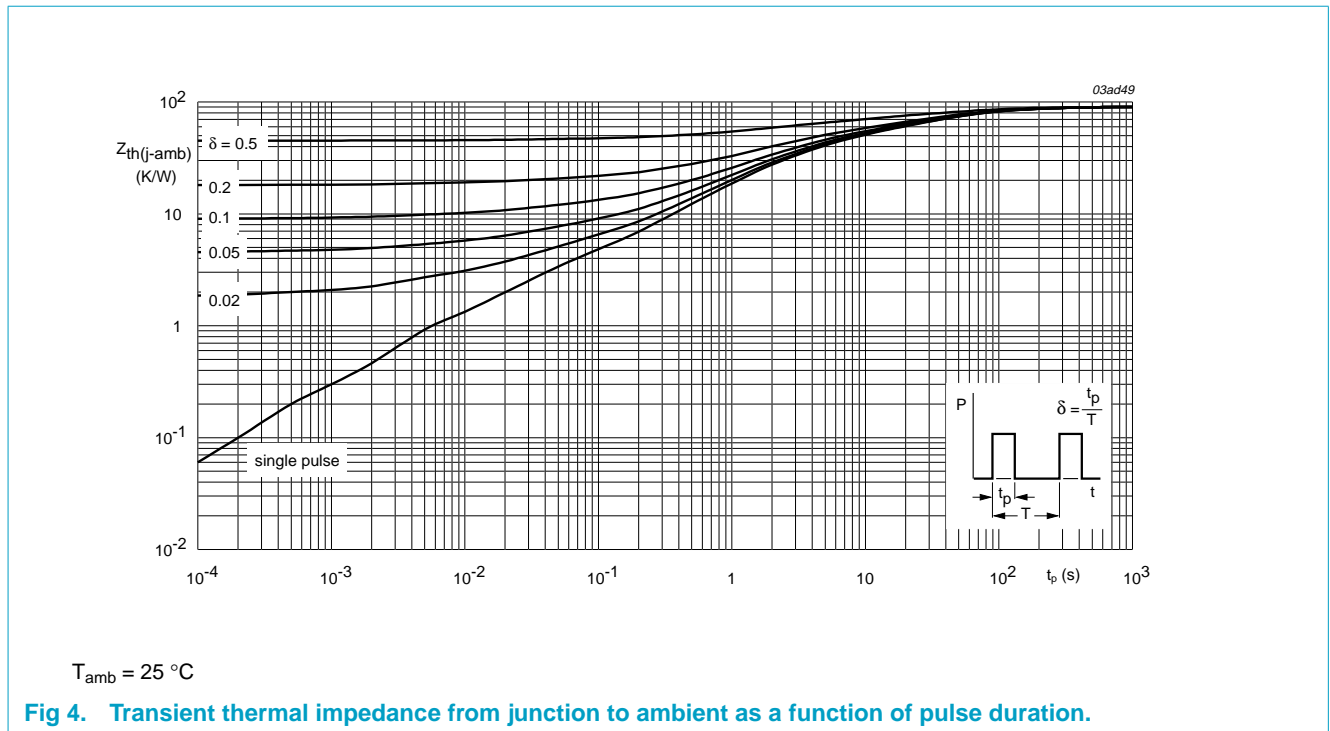
Fig 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage.

7. Thermal characteristics

Table 4: Thermal characteristics

Symbol	Parameter	Conditions	Value	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	mounted on a printed circuit board; $t_p \leq 10$ s; minimum footprint; Figure 4	50	K/W

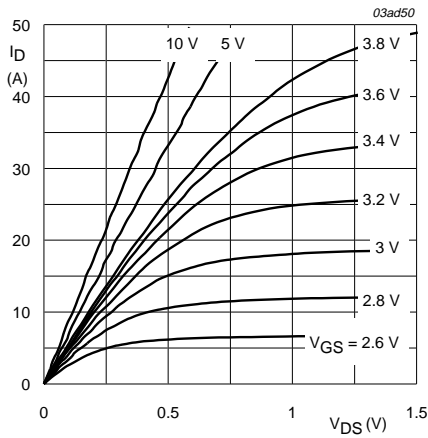
7.1 Transient thermal impedance



8. Characteristics

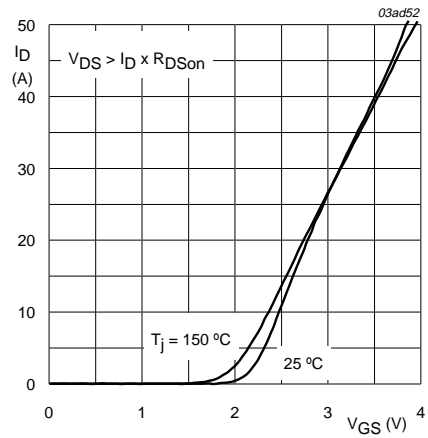
Table 5: Characteristics
 $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static characteristics						
$V_{GS(th)}$	gate-source threshold voltage	$I_D = 250\ \mu\text{A}$; $V_{DS} = V_{GS}$; $T_j = 25\text{ }^\circ\text{C}$; Figure 9	1	–	–	V
I_{DSS}	drain-source leakage current	$V_{DS} = 30\text{ V}$; $V_{GS} = 0\text{ V}$				
		$T_j = 25\text{ }^\circ\text{C}$	–	–	1	μA
		$T_j = 55\text{ }^\circ\text{C}$	–	–	25	μA
I_{GSS}	gate-source leakage current	$V_{GS} = \pm 20\text{ V}$; $V_{DS} = 0\text{ V}$	–	–	100	nA
$I_{D(on)}$	On-state drain current	$V_{DS} \geq 5$; $V_{GS} = 10\text{ V}$	20	–	–	A
$R_{DS(on)}$	drain-source on-state resistance	$V_{GS} = 10\text{ V}$; $I_D = 10\text{ A}$; Figure 7 and 8	–	11	13.5	m Ω
		$V_{GS} = 4.5\text{ V}$; $I_D = 5\text{ A}$; Figure 7 and 8	–	15	20	m Ω
Dynamic characteristics						
g_{fs}	forward transconductance	$V_{DS} = 15\text{ V}$; $I_D = 10\text{ A}$; Figure 11	–	34	–	S
$Q_{g(tot)}$	total gate charge	$I_D = 10\text{ A}$; $V_{DD} = 15\text{ V}$; $V_{GS} = 5\text{ V}$; Figure 14	–	21.5	34	nC
$Q_{g(tot)}$	total gate charge	$I_D = 10\text{ A}$; $V_{DD} = 15\text{ V}$; $V_{GS} = 10\text{ V}$; Figure 14	–	40	60	nC
Q_{gs}	gate-source charge		–	8	–	nC
Q_{gd}	gate-drain (Miller) charge		–	7	–	nC
$t_{d(on)}$	turn-on delay time	$V_{DD} = 25\text{ V}$; $R_D = 25\ \Omega$; $V_{GS} = 10\text{ V}$; $R_G = 6\ \Omega$	–	13.5	30	ns
t_r	rise time		–	9	20	ns
$t_{d(off)}$	turn-off delay time		–	70	100	ns
t_f	fall time		–	30	80	ns
Source-drain (reverse) diode						
V_{SD}	source-drain (diode forward) voltage	$I_S = 2.3\text{ A}$; $V_{GS} = 0\text{ V}$; Figure 13	–	0.7	1.1	V
t_{rr}	reverse recovery time	$I_S = 2.3\text{ A}$; $di_S/dt = -100\text{ A}/\mu\text{s}$; $V_{GS} = 0\text{ V}$	–	50	80	ns



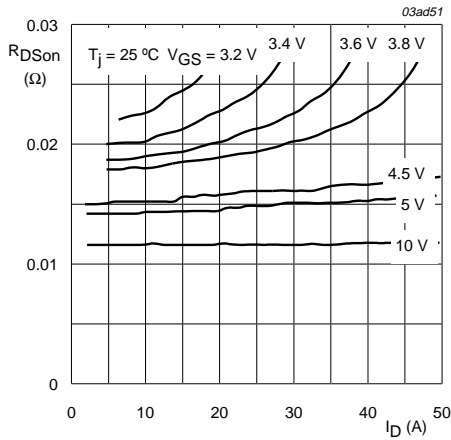
$T_j = 25\text{ }^\circ\text{C}$

Fig 5. Output characteristics: drain current as a function of drain-source voltage; typical values.



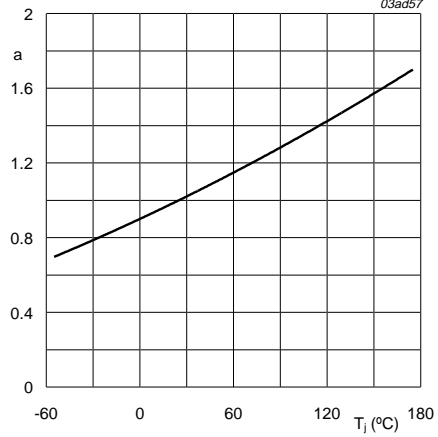
$T_j = 25\text{ }^\circ\text{C}$ and $150\text{ }^\circ\text{C}$; $V_{DS} > I_D \times R_{DSon}$

Fig 6. Transfer characteristics: drain current as a function of gate-source voltage; typical values.



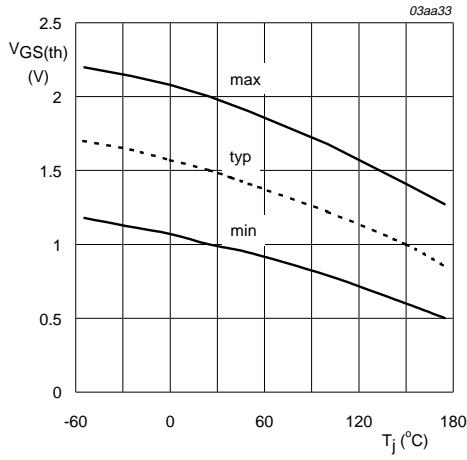
$T_j = 25\text{ }^\circ\text{C}$

Fig 7. Drain-source on-state resistance as a function of drain current; typical values.



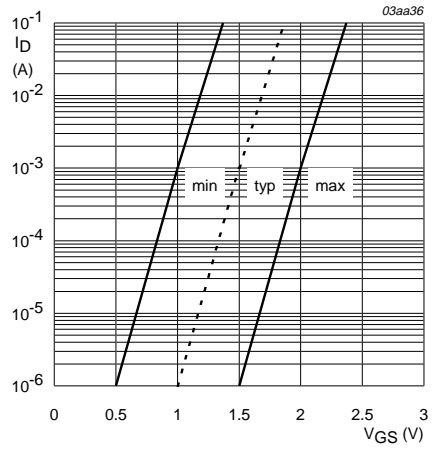
$$a = \frac{R_{DSon}}{R_{DSon(25^\circ\text{C})}}$$

Fig 8. Normalized drain-source on-state resistance factor as a function of junction temperature.



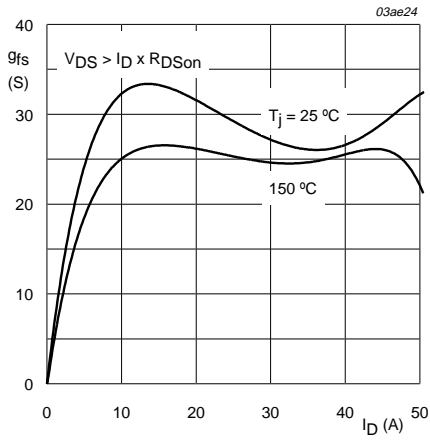
$I_D = 250 \mu\text{A}; V_{DS} = V_{GS}$

Fig 9. Gate-source threshold voltage as a function of junction temperature.



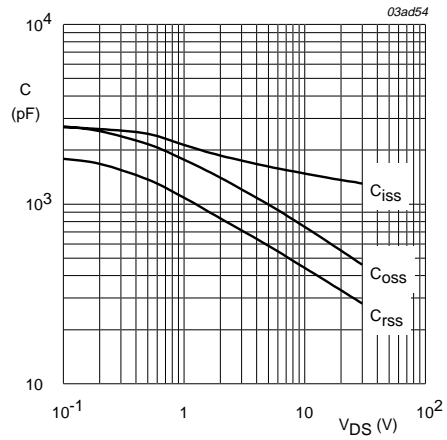
$T_j = 25 \text{ }^\circ\text{C}; V_{DS} = 5 \text{ V}$

Fig 10. Sub-threshold drain current as a function of gate-source voltage.



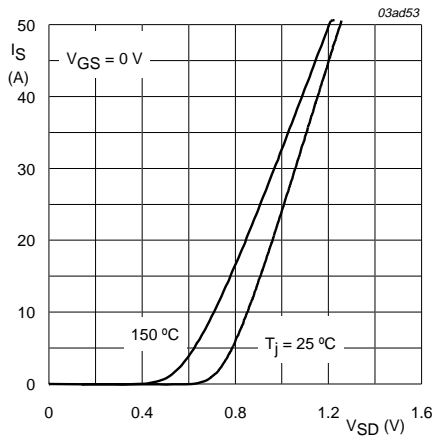
$T_j = 25 \text{ }^\circ\text{C}$ and $150 \text{ }^\circ\text{C}; V_{DS} > I_D \times R_{DSon}$

Fig 11. Forward transconductance as a function of drain current; typical values.



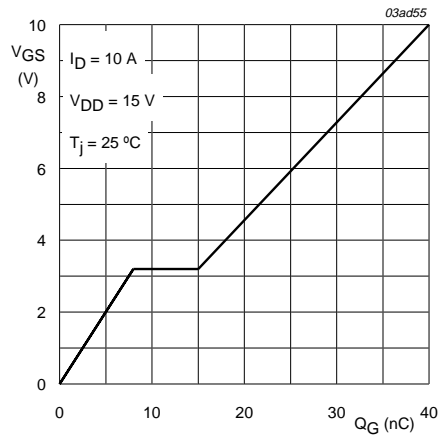
$V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}$

Fig 12. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values.



$T_j = 25\text{ °C}$ and 150 °C ; $V_{GS} = 0\text{ V}$

Fig 13. Source (diode forward) current as a function of source-drain (diode forward) voltage; typical values.



$I_D = 10\text{ A}$; $V_{DD} = 15\text{ V}$

Fig 14. Gate-source voltage as a function of gate charge; typical values.

9. Package outline

SO8: plastic small outline package; 8 leads; body width 3.9 mm

SOT96-1

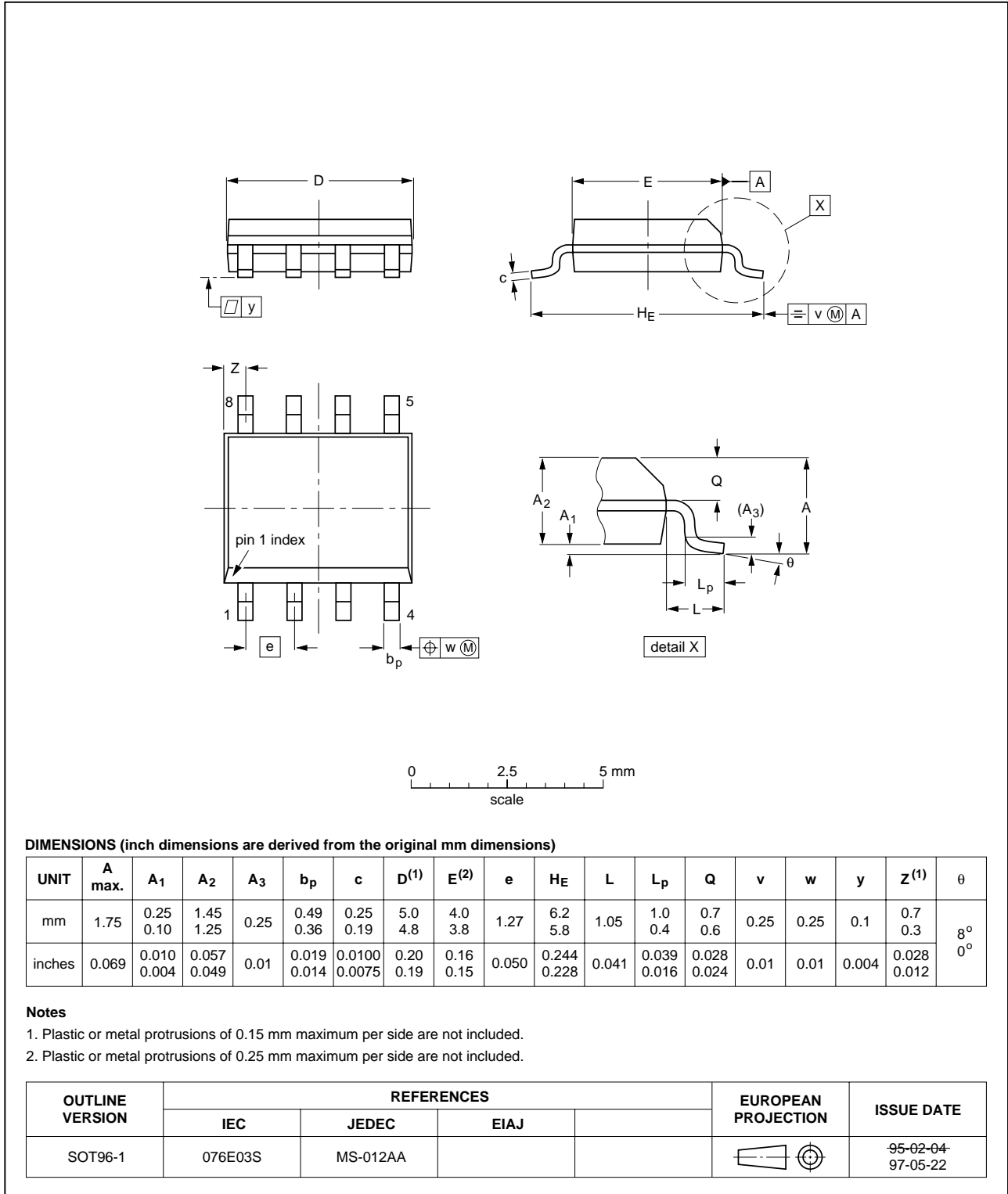


Fig 15. SOT96-1 (SO8).

10. Revision history

Table 6: Revision history

Rev	Date	CPCN	Description
02	20010705	-	Correction to I_{DM} condition
01	20010220	-	Product specification; initial version

11. Data sheet status

Data sheet status ^[1]	Product status ^[2]	Definition
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL <http://www.semiconductors.philips.com>.

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